

# STPSC20H065C

Datasheet - production data

### 650 V power Schottky silicon carbide diode

# A1 (1) A2 (3) K (2) A2 (3) TO-220ABSTPSC20H065CT K TO-220H065CT TO-247STPSC20H065CW

### **Features**

- No or negligible reverse recovery
- Switching behavior independent of temperature
- Dedicated to PFC applications
- High forward surge capability

### Description

The SiC diode is an ultrahigh performance power Schottky diode. It is manufactured using a silicon carbide substrate. The wide band gap material allows the design of a Schottky diode structure with a 650 V rating. Due to the Schottky construction, no recovery is shown at turn-off and ringing patterns are negligible. The minimal capacitive turn-off behavior is independent of temperature.

Especially suited for use in PFC applications, this ST SiC diode will boost the performance in hard switching conditions. Its high forward surge capability ensures a good robustness during transient phases.

#### Table 1. Device summary

Symbol	Value
I <sub>F(AV)</sub>	2 x 10 A
V <sub>RRM</sub>	650 V
T <sub>j</sub> (max)	175 °C

DocID023605 Rev 3

This is information on a product in full production.

## 1 Characteristics

## Table 2. Absolute ratings (limiting values per diode at 25 °C unless otherwise specified)

Symbol	Para	Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage		650	V	
I <sub>F(RMS)</sub>	Forward rms current		22	А	
1	Average ferward ourrent	$T_c = 135 \ ^{\circ}C^{(1)}$ , DC, per diode	10	Α	
I <sub>F(AV)</sub>	Average forward current	$T_c = 125 \ ^{\circ}C^{(2)}$ , per device	20	A	
	Surge per repetitive ferward	$t_p = 10 \text{ ms sinusoidal}, T_c = 25 \text{ °C}$			
I <sub>FSM</sub>	Surge non repetitive forward current	$t_p = 10 \text{ ms sinusoidal}, T_c = 125 \text{ °C}$	80	А	
		$t_p = 10 \ \mu s \ square, \ T_c = 25 \ ^\circ C$	470		
I <sub>FRM</sub>	$\label{eq:respective} \mbox{Repetitive peak forward current} \qquad T_c = 135 \ ^\circ C^{(1)}, \ T_j = 175 \ ^\circ C, \ \delta = 0.1$		36	А	
T <sub>stg</sub>	Storage temperature range	-55 to +175	°C		
Тj	Operating junction temperature <sup>(3)</sup>	-40 to +175	°C		

1. Value based on  $R_{th(j\text{-}c)} \max$  (per diode)

2. Value based on  $\mathsf{R}_{th(j\text{-}c)}$  max (per device)

3.  $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

#### Table 3. Thermal resistance

Symbol	Parameter			Value		Unit
Symbol				Тур.	Max.	Unit
	Per diode	TO-247	1.25	1.5		
	Junction to case per diode	Fel diode	TO-220AB	1.20	1.5	°C/W
R <sub>th(j-c)</sub>		Tetel	TO-247	0.83	0.95	
		Total	TO-220AB	0.05		
R <sub>th(c)</sub>	Coupling					

When the two diodes 1 and 2 are used simultaneously:

 $\Delta T_{j}(\text{diode 1}) = P(\text{diode 1}) \times R_{\text{th}(j-c)}(\text{Per diode}) + P(\text{diode 2}) \times R_{\text{th}(c)}$ 

#### Table 4. Static electrical characteristics per diode

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I <sub>B</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-	9	100	μA
'R`´	R <sup>()</sup> Reverse leakage current	T <sub>j</sub> = 150 °C		-	85	425	
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 25 °C	- I <sub>F</sub> = 10 A	-	1.56	1.75	V
V <sub>F</sub> <sup>(=)</sup> Forward voltage c	Torward voltage drop	T <sub>j</sub> = 150 °C		-	1.98	2.5	v

1.  $t_p = 10 \text{ ms}, \delta < 2\%$ 

2.  $t_p = 500 \ \mu s, \ \delta < 2\%$ 

To evaluate the conduction losses use the following equation:

 $P = 1.35 \text{ x } I_{F(AV)} + 0.115 \text{ x } I_{F}^{2}(RMS)$ 



V<sub>FM</sub>(V)

7

8

Symbol	Parameter	Test conditions	Тур.	Unit
Q <sub>cj</sub> <sup>(1)</sup>	Total capacitive charge	V <sub>R</sub> = 400 V	28.5	nC
C <sub>j</sub> Total capacit		V <sub>R</sub> = 0 V, T <sub>c</sub> = 25 °C, F = 1 MHz	480	рF
	Total capacitance	V <sub>R</sub> = 400 V, T <sub>c</sub> = 25 °C, F = 1 MHz	48	pr

<sub>FM</sub>(A)

Pulse test : t,=500µs

100

90

80

70

60

50

40

30

20

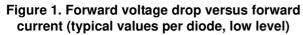
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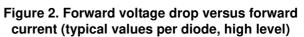
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Table 5. Dynamic electrical	characteristics per diode
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1. Most accurate value for the capacitive charge:  $Q_{cj} = \int_{0}^{V_{OUT}} c_{j}(v_R) dv_R$ 





T\_=25 °C

3

T<sub>a</sub>=100

2

. T<sub>a</sub>=150

1

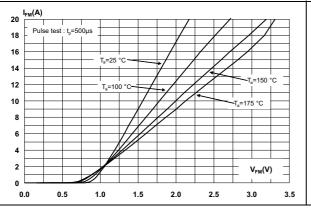


Figure 3. Reverse leakage current versus reverse voltage applied (typical values per diode)

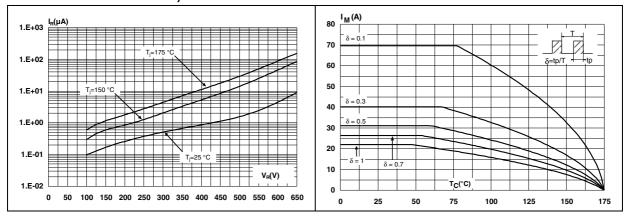
Figure 4. Peak forward current versus case temperature, per diode

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т<sub>а</sub>=175 °С

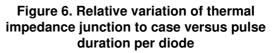
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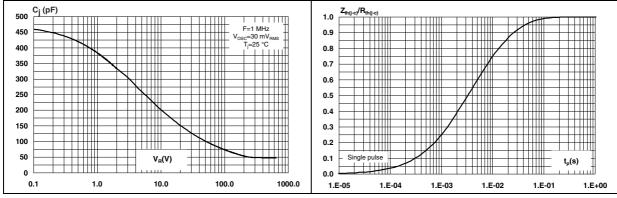
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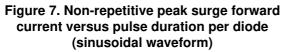


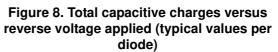


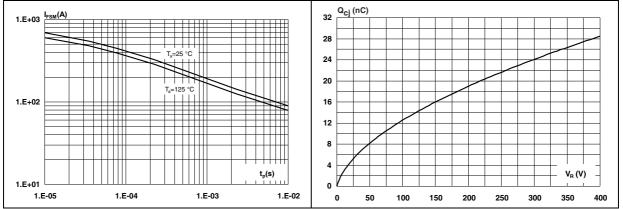
# Figure 5. Junction capacitance versus reverse voltage applied (typical values, per diode)









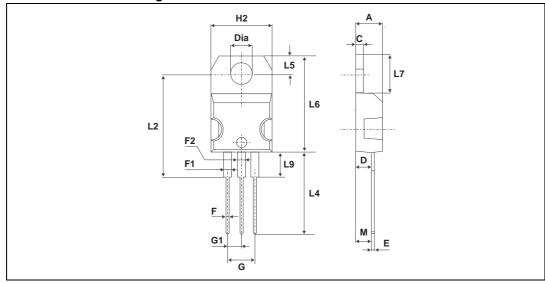




### 2 Package information

- Epoxy meets UL94, V0
- Cooling method: conduction (C)
- Recommended torque value:
  - TO-220AB 0.4 to 0.6 N·m,
  - TO-247 0.55 N·m (1.0 N·m maximum)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



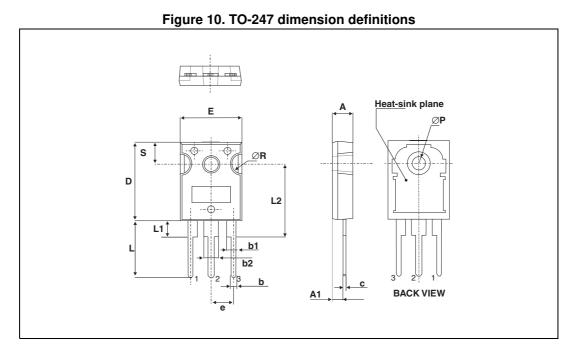
#### Figure 9. TO-220AB dimension definitions



	Dimensions					
Ref.	Millim	eters	Inches			
-	Min.	Max.	Min.	Max.		
А	4.40	4.60	0.173	0.181		
С	1.23	1.32	0.048	0.051		
D	2.40	2.72	0.094	0.107		
E	0.49	0.70	0.019	0.027		
F	0.61	0.88	0.024	0.034		
F1	1.14	1.70	0.044	0.066		
F2	1.14	1.70	0.044	0.066		
G	4.95	5.15	0.194	0.202		
G1	2.40	2.70	0.094	0.106		
H2	10	10.40	0.393	0.409		
L2	16.4	typ.	0.645 typ.			
L4	13	14	0.511	0.551		
L5	2.65	2.95	0.104	0.116		
L6	15.25	15.75	0.600	0.620		
L7	6.20	6.60	0.244	0.259		
L9	3.50	3.93	0.137	0.154		
М	2.6	typ.	0.102	2 typ.		
Diam.	3.75	3.85	0.147	0.151		

Table 6. TO-220AB dimension values





#### Table 7. TO-247 dimension values

	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур	Max.
А	4.85		5.15	0.191		0.203
A1	2.20		2.60	0.086		0.102
b	1.00		1.40	0.039		0.055
b1	2.00		2.40	0.078		0.094
b2	3.00		3.40	0.118		0.133
С	0.40		0.80	0.015		0.031
D <sup>(1)</sup>	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е	5.30	5.45	5.60	0.209	0.215	0.220
L	14.20		14.80	0.559		0.582
L1	3.70		4.30	0.145		0.169
L2		18.50 typ.			0.728 typ.	
ØP <sup>(2)</sup>	3.55		3.65	0.139		0.143
ØR	4.50		5.50	0.177		0.217
S	5.30	5.50	5.70	0.209	0.216	0.224

1. Dimension D plus gate protrusion does not exceed 20.5 mm

2. Resin thickness around the mounting hole is not less than 0.9 mm



## **3** Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPSC20H065CT	STPSC20H065C	TO-220AB	1.86 g	50	Tube
STPSC20H065CW	STPSC20H065CW	TO-247	4.43 g	30	Tube

## 4 Revision history

#### Table 9. Document revision history

Date	Revision	Changes
31-Aug-2012	1	First issue.
10-Oct-2012	2	Added Max. values to <i>Table 3</i> .
07-Nov-2013	3	Updated Figure 1 and Figure 2.



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